

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Appl. No.: 10/565916 Confirmation No.: 9371  
Applicant: CHENG, *et al.*  
Filed: 25/JAN/2006  
TC/A.U.: 2813  
Examiner: S.W. Smoot  
Docket No.: DC5157 PCT1  
Customer No.: 00137  
Date: 21 October 2010  
For: Process for Fabricating Electronic Components Using Liquid Injection Molding

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT**

Sir:

In response to the office action dated May 24, 2010, please amend the above-identified application as follows. The three-month response date was August 24, 2010. Applicants concurrently submit a request for a two-month extension. Therefore, this response is being timely filed.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 7 of this paper.